

## N-Channel Enhancement-Mode Vertical DMOS FET

## Features

- Low threshold (1.6V max.)
- High input impedance
- Low input capacitance
- Fast switching speeds
- Low on-resistance
- Free from secondary breakdown
- Low input and output leakage


## Applications

- Logic level interfaces - ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives
- Analog switches
- General purpose line drivers
- Telecom switches


## General Description

This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

## Ordering Information

| Device | Package Options |  | Wafer / Die Options |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | TO-92 | TO-243AA (SOT-89) | NW <br> (Die in wafer form) | (Die on adhesive tape) | (Die in waffle pack) |
| TN0104 | TN0104N3-G | TN0104N8-G | TN1504NW | TN1504NJ | TN1504ND |

For packaged products, -G indicates package is RoHS compliant ('Green'). Devices in Wafer / Die form are RoHS compliant ('Green'). Refer to Die Specification VF15 for layout and dimensions.

## Product Summary

| Device | $\underset{\mathrm{DSS}}{\mathrm{~V})} \mathrm{BV} \mathrm{VV}_{\mathrm{DCS}}$ | $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ (max) (』) | $I_{D(0 N)}$ <br> (min) <br> (A) |
| :---: | :---: | :---: | :---: |
| TN0104N3-G | 40 | 1.8 | 2.0 |
| TN0104N8-G | 40 | 2.0 | 2.0 |

## Absolute Maximum Ratings

| Parameter | Value |
| :--- | ---: |
| Drain-to-source voltage | $\mathrm{BV}_{\text {DSS }}$ |
| Drain-to-gate voltage | $\mathrm{BV}_{\text {DGS }}$ |
| Gate-to-source voltage | $\pm 20 \mathrm{~V}$ |
| Operating and storage temperature | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

[^0] may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

## Pin Configurations



TO-92 (N3)


TO-243AA (SOT-89) (N8)

Product Marking

| SiTN |
| :---: |
| 011 |
| 0 |
| YYWW |

YY = Year Sealed
WW = Week Sealed
___ = "Green" Packaging
Package may or may not include the following marks: Si or (7)
TO-92 (N3)
TN1LW
W = Code for Week Sealed = "Green" Packaging

## Thermal Characteristics

| Package | $\underset{\left(\mathrm{mA}^{(\text {continuous })}\right.}{\mathrm{I}_{\mathrm{D}}}$ | (pulsed) <br> (A) | Power Dissipation $@ \mathrm{~T}_{\mathrm{c}}=25^{\circ} \mathrm{C}$ <br> (W) | $\begin{gathered} \boldsymbol{\theta}_{j c} \\ \left({ }^{\circ} \mathrm{C} / \mathrm{W}\right) \end{gathered}$ | $\begin{gathered} \boldsymbol{\theta}_{j a} \\ \left({ }^{\circ} \mathrm{C} / \mathrm{W}\right) \end{gathered}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{DR}}{ }^{\prime} \\ & (\mathrm{mA}) \end{aligned}$ | $I_{\text {DRM }}$ <br> (A) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TO-92 | 450 | 2.40 | 1.0 | 125 | 170 | 450 | 2.40 |
| TO-243AA (SOT-89) | 630 | 2.90 | $1.6{ }^{\ddagger}$ | 15 | $78^{ \pm}$ | 630 | 2.90 |

## Notes:

$\dagger \quad I_{D}$ (continuous) is limited by max rated $T_{j}$.
$\ddagger T_{A}=25^{\circ} \mathrm{C}$. Mounted on FR5 Board, $25 \mathrm{~mm} \times 25 \mathrm{~mm} \times 1.57 \mathrm{~mm}$. Significant $P_{D}$ increase possible on ceramic substrate.
Electrical Characteristics ( $T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified)

| Sym | Parameter |  | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $B V_{\text {Dss }}$ | Drain-to-source breakdown voltage |  | 40 | - | - | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.0 \mathrm{~mA}$ |
| $\mathrm{V}_{\text {GS(th) }}$ | Gate threshold voltage |  | 0.6 | - | 1.6 | V | $V_{G S}=V_{\text {DS }}, I_{D}=500 \mu \mathrm{~A}$ |
| $\Delta V_{\text {GS(th) }}$ | Change in $\mathrm{V}_{\text {GS(th) }}$ with temperature |  | - | -3.8 | -5.0 | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ | $V_{G S}=V_{D S}, I_{D}=1.0 \mathrm{~mA}$ |
| $\mathrm{I}_{\text {gss }}$ | Gate body leakage |  | - | 0.1 | 100 | nA | $V_{G S}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\text {DS }}=0 \mathrm{~V}$ |
| $\mathrm{I}_{\text {DSs }}$ | Zero gate voltage drain current |  | - | - | 1.0 |  | $\mathrm{V}_{G S}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=$ Max Rating |
|  |  |  | - | - | 100 | $\mu \mathrm{A}$ | $\begin{aligned} & V_{\text {DS }}=0.8 \mathrm{Max} \text { Rating, } \\ & \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=125^{\circ} \mathrm{C} \end{aligned}$ |
| $\mathrm{I}_{\text {D(ON) }}$ | On-state drain current |  | - | 0.35 | - |  | $\mathrm{V}_{\mathrm{GS}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=20 \mathrm{~V}$ |
|  |  |  | 0.5 | 1.1 | - | A | $\mathrm{V}_{G S}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {DS }}=20 \mathrm{~V}$ |
|  |  |  | 2.0 | 2.6 | - |  | $V_{G S}=10 \mathrm{~V}, \mathrm{~V}_{\text {DS }}=20 \mathrm{~V}$ |
| $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ | Static drain-to-source on-state resistance | Both packages | - | 5.0 | - | $\Omega$ | $\mathrm{V}_{G S}=3.0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=50 \mathrm{~mA}$ |
|  |  |  | - | 2.3 | 2.5 |  | $\mathrm{V}_{\text {GS }}=5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mathrm{~mA}$ |
|  |  | TO-92 | - | 1.5 | 1.8 |  | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.0 \mathrm{~A}$ |
|  |  | TO-243AA | - | - | 2.0 |  |  |
| $\Delta \mathrm{R}_{\text {DS(ON) }}$ | Change in $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ with temperature |  | - | 0.7 | 1.0 | \%/ ${ }^{\circ} \mathrm{C}$ | $V_{G S}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1.0 \mathrm{~A}$ |
| $\mathrm{G}_{\text {FS }}$ | Forward transductance |  | 340 | 450 | - | mmho | $\mathrm{V}_{\mathrm{DS}}=20 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=500 \mathrm{~mA}$ |
| $\mathrm{C}_{\text {ISs }}$ | Input capacitance |  | - | - | 70 |  |  |
| $\mathrm{C}_{\text {oss }}$ | Common source output capacitance |  | - | - | 50 | pF | $\mathrm{V}_{\text {DS }}=20 \mathrm{~V}$, |
| $\mathrm{C}_{\text {RSS }}$ | Reverse transfer capacitance |  | - | - | 15 |  | $\mathrm{f}=1.0 \mathrm{MHz}$ |
| $\mathrm{t}_{\mathrm{d} \text { (ON) }}$ | Turn-on delay time |  | - | 3.0 | 5.0 | ns | $\begin{aligned} & V_{D D}=20 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{D}}=1.0 \mathrm{~A}, \\ & \mathrm{R}_{\mathrm{GEN}}=25 \Omega \end{aligned}$ |
| $\mathrm{t}_{\mathrm{r}}$ | Rise time |  | - | 7.0 | 8.0 |  |  |
| $\mathrm{t}_{\text {d(OFF) }}$ | Turn-off delay time |  | - | 6.0 | 9.0 |  |  |
| $\mathrm{t}_{\mathrm{f}}$ | Fall time |  | - | 5.0 | 8.0 |  |  |
| $\mathrm{V}_{\text {sD }}$ | Diode forward voltage drop | TO-92 | - | 1.2 | 1.8 | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\text {SD }}=1.0 \mathrm{~A}$ |
|  |  | TO-243AA | - | - | 2.0 |  | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\text {SD }}=0.5 \mathrm{~A}$ |
| $\mathrm{t}_{\text {tr }}$ | Reverse recovery time |  | - | 300 | - | ns | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{SD}}=1.0 \mathrm{~A}$ |

## Notes:

1. All D.C. parameters $100 \%$ tested at $25^{\circ} \mathrm{C}$ unless otherwise stated. (Pulse test: $300 \mu \mathrm{~s}$ pulse, $2 \%$ duty cycle.)
2. All A.C. parameters sample tested.

Switching Waveforms and Test Circuit


## Typical Performance Curves






Power Dissipation vs. Case Temperature



## Typical Performance Curves (cont.)




## Capacitance vs. Drain-to-Source Voltage






## 3-Lead TO-92 Package Outline (N3)



Front View


Side View


Bottom View

| Symbol |  | A | b | c | D | E | E1 | e | e1 | L |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimensions (inches) | MIN | . 170 | . $014{ }^{+}$ | . $014{ }^{\dagger}$ | . 175 | . 125 | . 080 | . 095 | . 045 | . 500 |
|  | NOM | - | - | - | - | - | - | - | - | - |
|  | MAX | . 210 | . $022{ }^{+}$ | . $022{ }^{\dagger}$ | . 205 | . 165 | . 105 | . 105 | . 055 | .610* |

JEDEC Registration TO-92.

* This dimension is not specified in the JEDEC drawing.
$\dagger$ This dimension differs from the JEDEC drawing.
Drawings not to scale.
Supertex Doc.\#: DSPD-3TO92N3, Version E041009.


## 3-Lead TO-243AA (SOT-89) Package Outline (N8)



Top View


Side View

| Symbol |  | A | b | b1 | C | D | D1 | E | E1 | e | e1 | H | L |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimensions (mm) | MIN | 1.40 | 0.44 | 0.36 | 0.35 | 4.40 | 1.62 | 2.29 | $2.00^{+}$ | $\begin{aligned} & 1.50 \\ & \text { BSC } \end{aligned}$ | $\begin{aligned} & 3.00 \\ & \text { BSC } \end{aligned}$ | 3.94 | $0.73{ }^{+}$ |
|  | NOM | - | - | - | - | - | - | - | - |  |  | - | - |
|  | MAX | 1.60 | 0.56 | 0.48 | 0.44 | 4.60 | 1.83 | 2.60 | 2.29 |  |  | 4.25 | 1.20 |

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.
$t$ This dimension differs from the JEDEC drawing
Drawings not to scale.
Supertex Doc. \#: DSPD-3TO243AAN8, Version F111010.
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

[^1]
[^0]:    Absolute Maximum Ratings are those values beyond which damage to the device

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